

Material Data Sheet

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|---|---|---|
| Ν | Т | U |

| B57xxxS* | | Inrush Current Limiting B57xxxS* B57127P508*, | | | | | | | | | | |
|---|--|---|---|---|--------|---|--|---|--|--|--|--|
| | | 30.09.2019 | | | | | | | | | | |
| IMDS ID if available | | | | | | | | | | | | |
| Version: 5.08 | | | | | | | | | | | | |
| Product Part (IMDS: semi component) | Material (IMDS N | | Material (Classification) VDA 231 | Substance | | | TMPS**) [wt%] | | CAS if applicable | typical mass of material [wt-%] | Traces see 1) | |
| Active Part | Ceramic | | 3B | Mn3O4 NiO Co3O4 others*) | | | 64 17 15 4 | | 1317-35-7 1313-99-1 1308-06-1 | 63 | | |
| Termination | Compos | ite | 4D | Ag | Ag 95 | | 7440-22-4 | 1 | | | | |
| | | | | Glass frit (boro-silicate) | | 5 | | | | | | |
| Solder | Heavy M | letal | al 1C15 Pb +) Sn Sb | | | | 91 8 1 | | 7439-92-1 7440-31-5 7440-36-0 | 6 | | |
| Leads | Heavy N | letal | 1C12 | Cu | | | 100 | 100 7440-50-8 | | 21 | | |
| | Heavy N | letal | 1C8 | Sn | | | 100 7440-31-5 | | 1 | | | |
| Encapsulation | n Organic, solid 4B | | | SiO2 Silicone C.I. Pigment black 28 others*) | | | 82,5 60676-86-0 9 67763-03-5 6 68186-91-4 2,5 | | 8 | | | |
| | 1 | | I | | | | | I | Sum in total: | 100 | 1 | |
| sizes [mm] 49 x 8.5 x 6 54 x 15 x 7 54 x 15 x 7 | weight rang 0.3 - 1.0 1.6 - 3.3 1.1 - 3.3 | ye [g] material numbers B57153S* B57234S* B57237S* | sizes [mm 50 x 9.5 x 52 x 11.5 55 x 16 x | 6 0.6 - 1.3 6 0.9 - 1.9 | e[g] | material numbers B57235S* B57236S* B57238S* | | sizes [m 71 x 31 : 63 x 26 : 60 x 21 : | x 7 9.0 - 13.0 x 7 8.0 - 12.0 | e [g] material B57127 B57464 B57364 | S* | |
| Not part of a Pr | oduct Cla | ss B57237S0479A | .006, B57237S | 5*C21,B57238S* C | 21,B57 | '364S* C21, B57xxxS | 5***V 9 | | | | | |
| Contact N | /r. Christo | ph Ronner | | | Impo | rtant remarks: | | | | | | |
| | PD Q QN | • | | | 1) | , , , , | | | | | | |
| | | schlandsberg, AUSTR | | otherwise regulated. | | | nces etc. that are below a percentage of 0.1 % by weight, if not | | | | | |
| | 800 2139 mailto: function | tdk-electronics.tdk.com | electronics.tdk.com 2) This Material Data Sheet contains typical values of the respect herein. We expressly point out that all values and statements c | | | | | | | | | |
| **) typical mass (+) listed in the C Regulation 1907 | bercentage andidate li /2006/EC | e of substance ist of Substances of Ve | ery High Conc | ern acc. to | | based on our best press or binding product spec ELECTRONICS AG AM REPRESENTATION OI STATUTORY, WITH RI HEREIN, INCLUDING B WARRANTY OF MERC | ifications ID ITS A R WARF EGARD BUT NO CHANTA | s, unles FFILIA RANTY, TO THE T LIMIT BILITY | s otherwise explicit TES HEREBY EXP WHETHER EXPR E STATEMENTS A ED TO ANY REPR OR SUITABILITY I | ly agreed in writ RESSLY DISCL ESS, IMPLIED (ND VALUES CO RESENTATION (FOR ANY PURF | ing. TDK AIM ANY DR DNTAINED DR 20SE. | |
| | | erein are "RoHS-com European Parliament and | | | | | | | | | | |
| RoHS - Exemptions; no exemptions; Exemption 6 (a): | | ne Product Class / Pr alloying element in steel for m | | - | | | t; | | | | | |
| Exemption 6 (b): | | alloying element in aluminium | | - | | , | | | | | | |
| Exemption 6 (c): | | containing up to 4 % lead by | - | | | | | | | | | |
| | - | melting temperature type sol d electronic components con | | | | | Diezoelect | tronic de | vices, or in a class or v | ceramic matrix com | nound. | |
| | | ectric ceramic in capacitors for | | | | | | | | | .pounu, | |
| | | | r a rated voltage of | | | | | | | | | |

Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;

Other Exemption than above